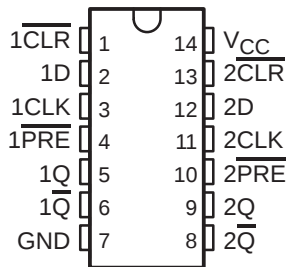


SN54LV74A, SN74LV74A DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

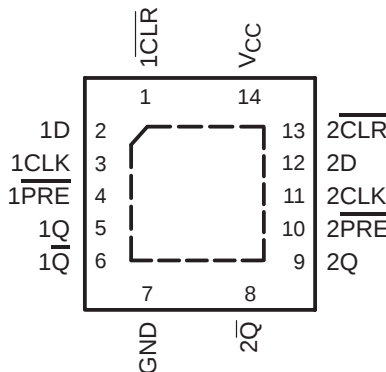
SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 8.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
<0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot)
>2.3 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

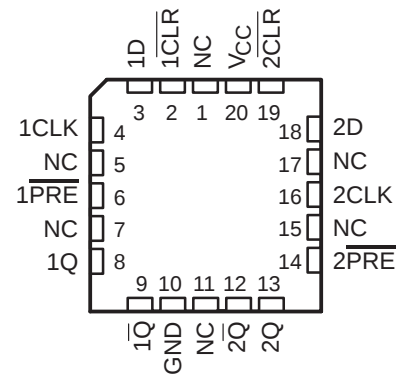
SN54LV74A ... J OR W PACKAGE
SN74LV74A ... D, DB, DGV, NS,
OR PW PACKAGE
(TOP VIEW)



SN74LV74A ... RGY PACKAGE
(TOP VIEW)



SN54LV74A ... FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

These dual positive-edge-triggered D-type flip-flops are designed for 2-V to 5.5-V V_{CC} operation.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QFN – RGY	Reel of 1000	SN74LV74ARGYR	LV74A
	SOIC – D	Tube of 50	SN74LV74AD	LV74A
		Reel of 2500	SN74LV74ADR	
	SOP – NS	Reel of 2000	SN74LV74ANSR	74LV74A
	SSOP – DB	Reel of 2000	SN74LV74ADBR	LV74A
	TSSOP – PW	Tube of 90	SN74LV74APW	LV74A
		Reel of 2000	SN74LV74APWR	
		Reel of 250	SN74LV74APWT	
	TVSOP – DGV	Reel of 2000	SN74LV74ADGVR	LV74A
-55°C to 125°C	CDIP – J	Tube of 25	SNJ54LV74AJ	SNJ54LV74AJ
	CFP – W	Tube of 150	SNJ54LV74AW	SNJ54LV74AW
	LCCC – FK	Tube of 55	SNJ54LV74AFK	SNJ54LV74AFK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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**TEXAS
INSTRUMENTS**

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SN54LV74A, SN74LV74A

DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

description/ordering information (continued)

A low level at the preset ($\overline{\text{PRE}}$) or clear ($\overline{\text{CLR}}$) inputs sets or resets the outputs, regardless of the levels of the other inputs. When $\overline{\text{PRE}}$ and $\overline{\text{CLR}}$ are inactive (high), data at the data (D) inputs meeting the setup-time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

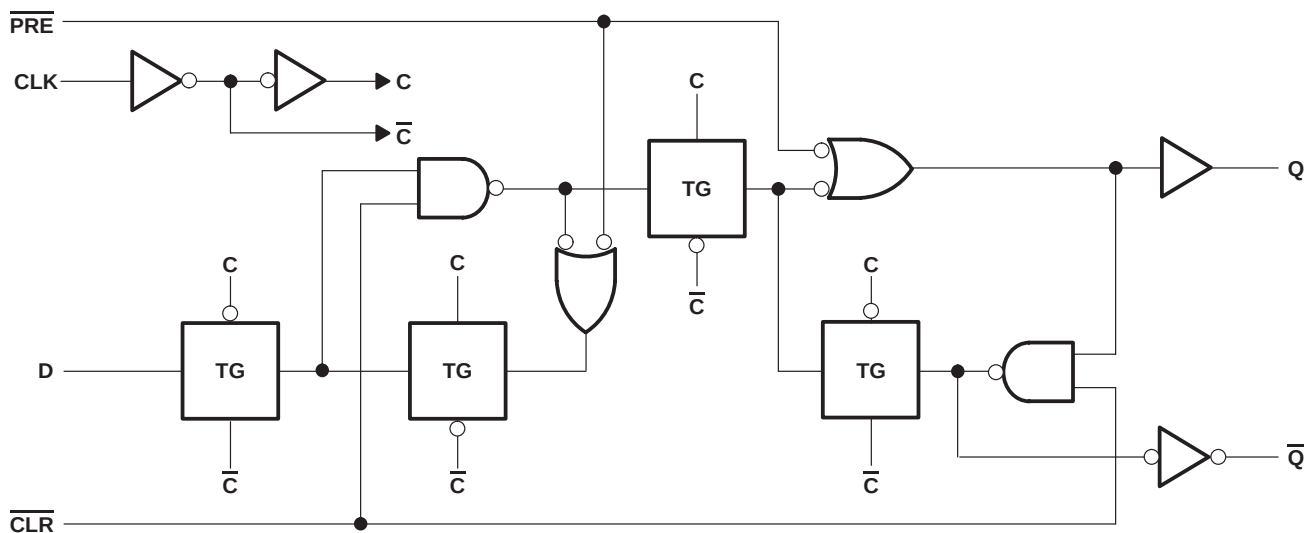
These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

FUNCTION TABLE

INPUTS				OUTPUTS	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	$\text{H}^\dagger$	$\text{H}^\dagger$
H	H	$\uparrow$	H	H	L
H	H	$\uparrow$	L	L	H
H	H	L	X	Q_0	$\overline{\text{Q}}_0$

† This configuration is nonstable; that is, it does not persist when PRE or CLR returns to its inactive (high) level.

logic diagram, each flip-flop (positive logic)



SN54LV74A, SN74LV74A

DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1)	–0.5 V to 7 V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	86°C/W
(see Note 3): DB package	96°C/W
(see Note 3): DGV package	127°C/W
(see Note 3): NS package	76°C/W
(see Note 3): PW package	113°C/W
(see Note 4): RGY package	47°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 4. The package thermal impedance is calculated in accordance with JESD 51-5.



SN54LV74A, SN74LV74A

DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

recommended operating conditions (see Note 5)

			SN54LV74A		SN74LV74A		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage		2	5.5	2	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 2 V	1.5		1.5		V
		V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.7		V _{CC} × 0.7		
		V _{CC} = 3 V to 3.6 V	V _{CC} × 0.7		V _{CC} × 0.7		
		V _{CC} = 4.5 V to 5.5 V	V _{CC} × 0.7		V _{CC} × 0.7		
V _{IL}	Low-level input voltage	V _{CC} = 2 V	0.5		0.5		V
		V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.3		V _{CC} × 0.3		
		V _{CC} = 3 V to 3.6 V	V _{CC} × 0.3		V _{CC} × 0.3		
		V _{CC} = 4.5 V to 5.5 V	V _{CC} × 0.3		V _{CC} × 0.3		
V _I	Input voltage		0	5.5	0	5.5	V
V _O	Output voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2 V	−50		−50		μA
		V _{CC} = 2.3 V to 2.7 V	−2		−2		mA
		V _{CC} = 3 V to 3.6 V	−6		−6		
		V _{CC} = 4.5 V to 5.5 V	−12		−12		
I _{OL}	Low-level output current	V _{CC} = 2 V	50		50		μA
		V _{CC} = 2.3 V to 2.7 V	2		2		mA
		V _{CC} = 3 V to 3.6 V	6		6		
		V _{CC} = 4.5 V to 5.5 V	12		12		
Δt/Δv	Input transition rise or fall rate	V _{CC} = 2.3 V to 2.7 V	200		200		ns/V
		V _{CC} = 3 V to 3.6 V	100		100		
		V _{CC} = 4.5 V to 5.5 V	20		20		
T _A	Operating free-air temperature		−55	125	−40	85	°C

NOTE 5: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	SN54LV74A			SN74LV74A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V _{OH}	I _{OH} = –50 μA	2 V to 5.5 V	V _{CC} –0.1			V _{CC} –0.1			V
	I _{OH} = –2 mA	2.3 V	2			2			
	I _{OH} = –6 mA	3 V	2.48			2.48			
	I _{OH} = –12 mA	4.5 V	3.8			3.8			
V _{OL}	I _{OL} = 50 μA	2 V to 5.5 V	0.1			0.1			V
	I _{OL} = 2 mA	2.3 V	0.4			0.4			
	I _{OL} = 6 mA	3 V	0.44			0.44			
	I _{OL} = 12 mA	4.5 V	0.55			0.55			
I _I	V _I = 5.5 V or GND	0 to 5.5 V	±1			±1			μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V	20			20			μA
I _{off}	V _I or V _O = 0 to 5.5 V	0	5			5			μA
C _i	V _I = V _{CC} or GND	3.3 V	2			2			pF
		5 V	2			2			

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SN54LV74A, SN74LV74A

DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

timing requirements over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER			$T_A = 25^\circ\text{C}$		SN54LV74A		SN74LV74A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	8		9		9		ns
		CLK	8		9		9		
t_{su}	Setup time before $\text{CLK}\uparrow$	Data	8		9		9		ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	7		7		7		
t_h	Hold time, data after $\text{CLK}\uparrow$		0.5		0.5		0.5		ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER			$T_A = 25^\circ\text{C}$		SN54LV74A		SN74LV74A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	6		7		7		ns
		CLK	6		7		7		
t_{su}	Setup time before $\text{CLK}\uparrow$	Data	6		7		7		ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	5		5		5		
t_h	Hold time, data after $\text{CLK}\uparrow$		0.5		0.5		0.5		ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER			$T_A = 25^\circ\text{C}$		SN54LV74A		SN74LV74A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_W	Pulse duration	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	5		5		5		ns
		CLK	5		5		5		
t_{su}	Setup time before $\text{CLK}\uparrow$	Data	5		5		5		ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ inactive	3		3		3		
t_h	Hold time, data after $\text{CLK}\uparrow$		0.5		0.5		0.5		ns

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV74A		SN74LV74A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			$C_L = 15\text{ pF}$	50*	100*		40*		40		MHz
			$C_L = 50\text{ pF}$	30	70		25		25		
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 15\text{ pF}$	9.8*	14.8*		1*	17*	1	17	ns
	CLK			11.1*	16.4*		1*	19*	1	19	
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 50\text{ pF}$	13	17.4		1	20	1	20	ns
	CLK			14.2	20		1	23	1	23	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV74A		SN74LV74A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\max}$			$C_L = 15\text{ pF}$	80*	140*		70*		70		MHz
			$C_L = 50\text{ pF}$	50	90		45		45		
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 15\text{ pF}$	6.9*	12.3*		1*	14.5*	1	14.5	ns
	CLK			7.9*	11.9*		1*	14*	1	14	
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 50\text{ pF}$	9.2	15.8		1	18	1	18	ns
	CLK			10.2	15.4		1	17.5	1	17.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV74A		SN74LV74A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\max}$			$C_L = 15\text{ pF}$	130*	180*		110*		110		MHz
			$C_L = 50\text{ pF}$	90	140		75		75		
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 15\text{ pF}$	5*	7.7*		1*	9*	1	9	ns
	CLK			5.6*	7.3*		1*	8.5*	1	8.5	
t_{pd}	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{Q}$	$C_L = 50\text{ pF}$	6.6	9.7		1	11	1	11	ns
	CLK			7.2	9.3		1	10.5	1	10.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 6)

PARAMETER		SN74LV74A			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}		0.1	0.8	V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}		0	-0.8	V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}		3.2		V
$V_{IH(D)}$	High-level dynamic input voltage	2.31			V
$V_{IL(D)}$	Low-level dynamic input voltage		0.99		V

NOTE 6: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^\circ\text{C}$

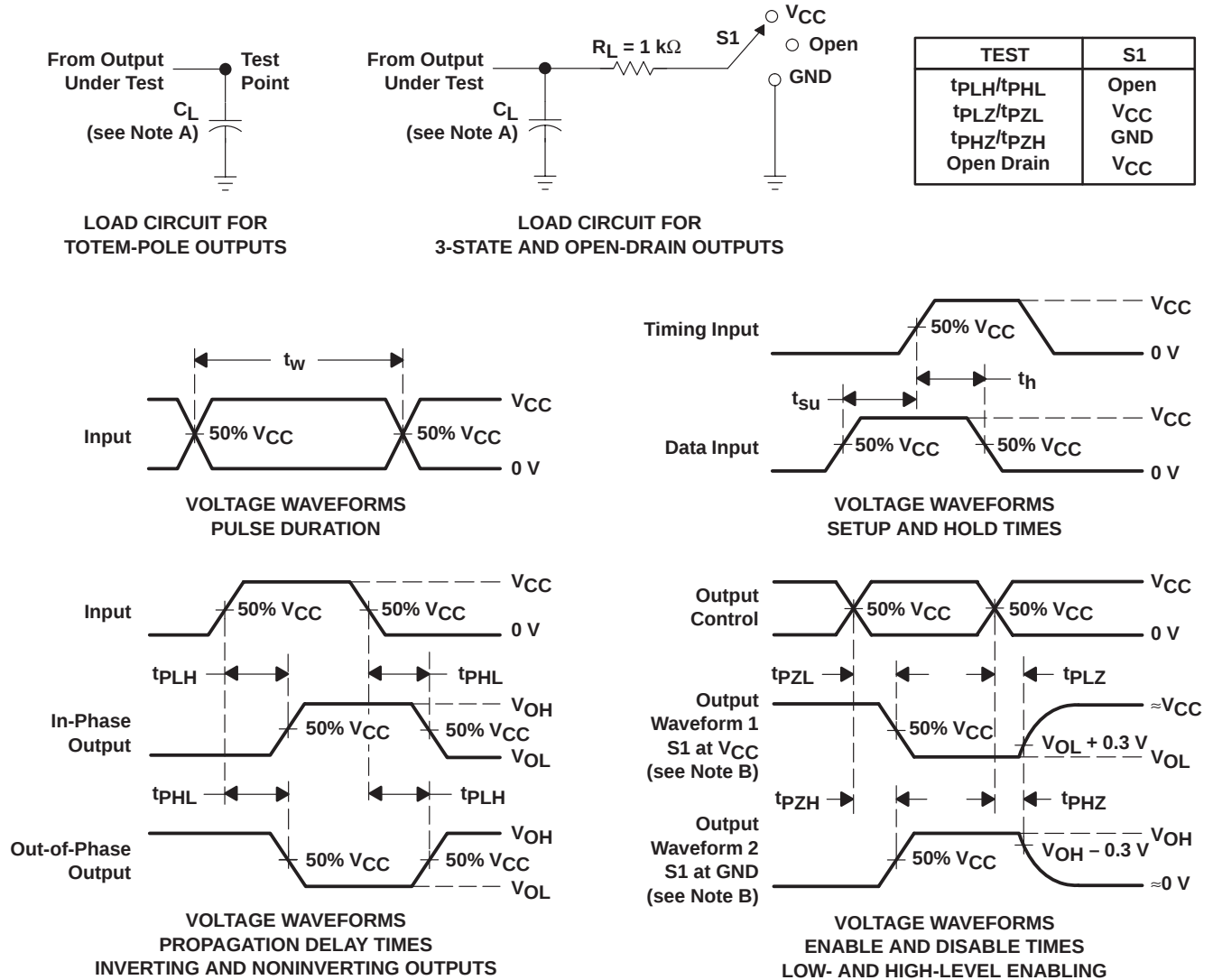
PARAMETER	TEST CONDITIONS	V_{CC}	TYP	UNIT
C_{pd} Power dissipation capacitance	$C_L = 50\text{ pF}$, $f = 10\text{ MHz}$	3.3 V	21	pF
		5 V	23	

SN54LV74A, SN74LV74A

DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381J – AUGUST 1997 – REVISED AUGUST 2003

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. t_{pLZ} and t_{pHZ} are the same as t_{dis} .
 - F. t_{pZL} and t_{pZH} are the same as t_{en} .
 - G. t_{pHL} and t_{pLH} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

D (R-PDSO-G14)

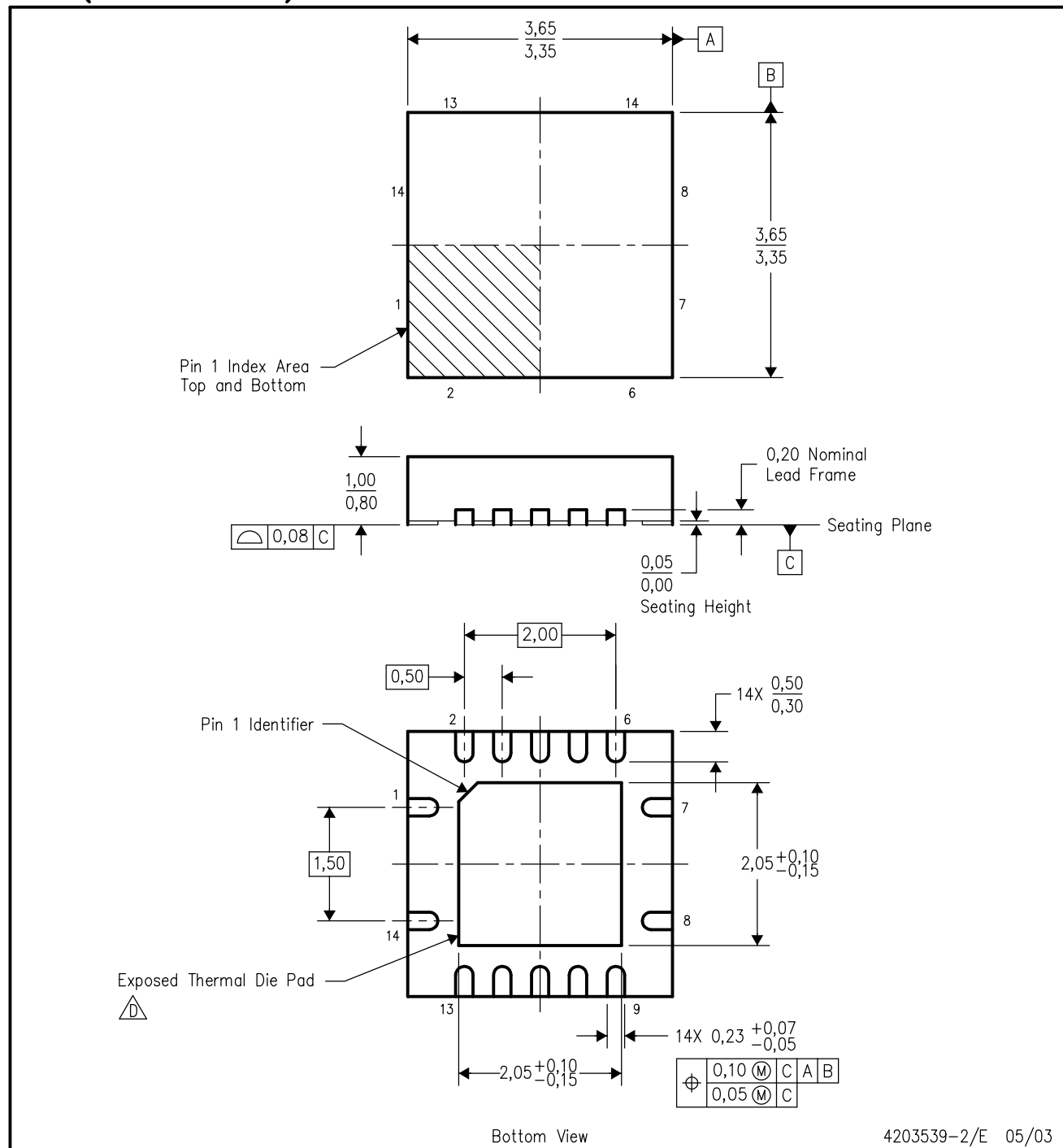
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AB.

RGY (S-PQFP-N14)

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. QFN (Quad Flatpack No-Lead) package configuration.
 - D. The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
 - E. Package complies to JEDEC MO-241 variation BA.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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